

EMC2103

RPM-Based Fan Controller with Hardware Thermal Shutdown

PRODUCT FEATURES

Data Brief

General Description

The EMC2103 is an SMBus compliant fan controller with up to up to 3 external and 1 internal temperature channels. The fan driver can be operated using two methods each with two modes. The methods include an RPM based Fan Speed Control Algorithm and a direct PWM drive setting. The modes include manually programming the desired settings or using the internal programmable temperature look-up table to select the desired setting based on measured temperature.

The temperature monitors offer 1°C accuracy (for external diodes) with sophisticated features to reduce errors introduced by series resistance and beta variation of substrate thermal diode transistors commonly found in processors.

The EMC2103 also includes a hardware programmable temperature limit and dedicated system shutdown output for thermal protection of critical circuitry.

Applications

- Notebook Computers
- Projectors
- Graphics Cards
- Industrial and Networking Equipment

Features

- Programmable Fan Control circuit
 - 4-wire fan compatible
 - High and low frequency PWM
- RPM based fan control algorithm
 - 2.5% accuracy from 500RPM to 16k RPM
 - Detects fan aging and variation
- Temperature Look-Up Table
 - Allows programmed fan response to temperature
 - Controls fan speed or PWM drive setting
 - Allows externally set temperature data to drive fan
 - Supports DTS data from CPU
- Up to Three External Temperature Channels (EMC2103-2 only)
 - Supports 45nm, 60nm, and 90nm CPU diodes
 - Automatically detects and supports CPUs requiring BJT or Transistor models
 - Resistance error correction
 - Supports discrete transistors (i.e. 2N3904)
 - 1°C accurate (60°C to 125°C)
 - 0.125°C resolution
- Hardware Programmable Thermal Shutdown Temperature
 - Cannot be altered by software
 - 65°C to 127°C Range
- Programmable High and Low Limits for all channels
- Internal Temperature Monitor
 - 2°C accuracy
 - 0.125°C resolution
- 3.3V Supply Voltage
- SMBus 2.0 Compliant
 - SMBus Alert compatible
- Two dedicated GPIOs (EMC2103-2 and EMC2103-4 only)
- Available in 12-pin, QFN Lead-Free RoHS Compliant Package (EMC2103-1 and EMC2103-3) or 16-pin, QFN Lead-Free RoHS Compliant Package (EMC2103-2 and EMC2103-4)



ORDER NUMBERS:

ORDERING NUMBER	PACKAGE	FEATURES
EMC2103-1-KP-TR	12-pin, QFN Lead-Free, ROHS Compliant	One external diode, RPM based Fan Speed Control Algorithm, High Frequency PWM driver, HW Thermal / Critical shutdown, EEPROM Load disabled
EMC2103-2-AP-TR	16-pin, QFN Lead-Free, ROHS Compliant	Up to three external diodes, RPM based Fan Speed Control algorithm, High Frequency PWM driver, HW Thermal / Critical shutdown, 2 GPIOs, EEPROM Load disabled
EMC2103-4-AP-TR	16-pin, QFN Lead-Free, ROHS Compliant	Up to three external diodes, RPM based Fan Speed Control algorithm, High Frequency PWM driver, HW Thermal / Critical shutdown, 2 GPIOs, EEPROM Load enabled

REEL SIZE IS 4,000 PIECES

This product meets the halogen maximum concentration values per IEC61249-2-21 For RoHS compliance and environmental information, please visit www.smsc.com/rohs



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Block Diagram

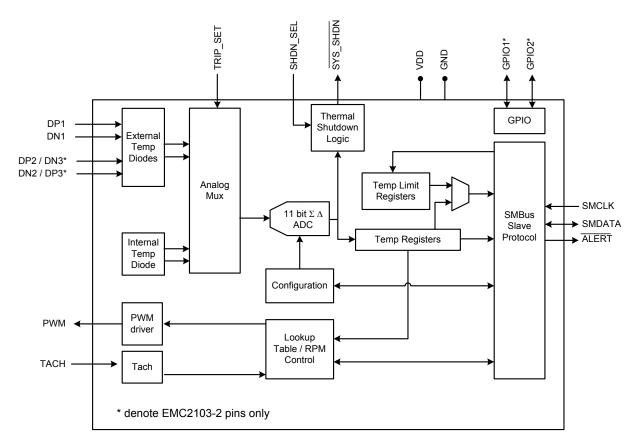


Figure 1 EMC2103 Block Diagram



EMC2103-1 Package Information

COMMON DIMENSIONS							
SYMBOL	MIN	NOM	MAX	NOTE	REMARK		
Α	0.80	0.85	0.90	-	OVERALL PACKAGE HEIGHT		
A1	0	0.02	0.05	-	STANDOFF		
A3	0.20 REF			-	LEAD-FRAME THICKNESS		
D/E	3.90	4.00	4.10	-	X/Y BODY SIZE		
D2/E2	2.00	2.10	2.20	2	X/Y EXPOSED PAD SIZE		
L	0.45	0.50	0.55	-	TERMINAL LENGTH		
b	0.25	0.30	0.35	2	TERMINAL WIDTH		
K	0.20	-	-	-	TERMINAL TO PAD DISTANCE		
е	0.80 BSC			-	TERMINAL PITCH		

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. POSITION TOLERANCE OF EACH TERMINAL AND EXPOSED PAD IS \pm 0.05mm AT MAXIMUM MATERIAL CONDITION. DIMENSIONS "b" APPLIES TO PLATED TERMINALS AND IT IS MEASURED BETWEEN 0.15 AND 0.30 mm FROM THE TERMINAL TIP.
- 3. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE AREA INDICATED.

Figure 2 Preliminary 12-Pin QFN 4mm x 4mm Package Dimensions

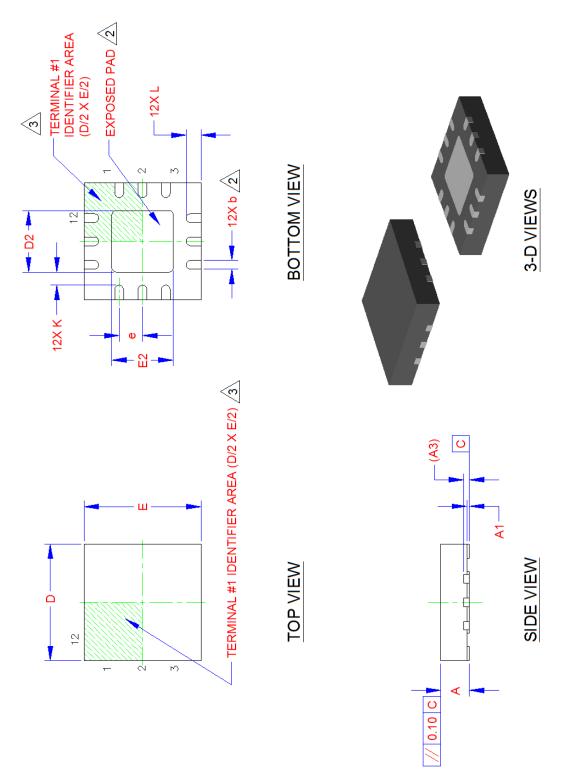
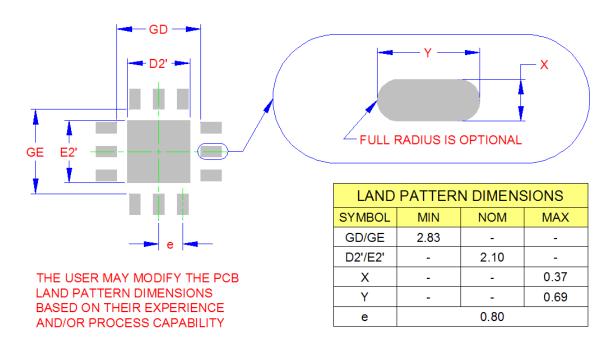


Figure 3 Preliminary 12-Pin QFN 4mm x 4mm Package Drawing





RECOMMENDED PCB LAND PATTERN

Figure 4 Recommended PCB Footprint 12-Pin QFN 4mm x 4mm



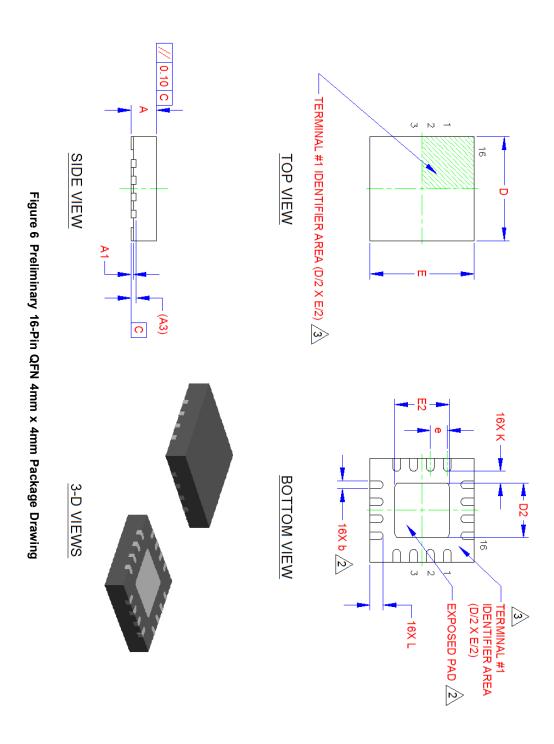
EMC2103-2 Package Information

COMMON DIMENSIONS							
SYMBOL	MIN	NOM	MAX	NOTE	REMARK		
Α	0.80	0.85	0.90	-	OVERALL PACKAGE HEIGHT		
A1	0	0.02	0.05	-	STANDOFF		
А3	0.20 REF			-	LEAD-FRAME THICKNESS		
D/E	3.90	4.00	4.10	-	X/Y BODY SIZE		
D2/E2	2.00	2.10	2.20	2	X/Y EXPOSED PAD SIZE		
L	0.45	0.50	0.55	-	TERMINAL LENGTH		
b	0.25	0.30	0.35	2	TERMINAL WIDTH		
K	0.20	-	-	-	TERMINAL TO PAD DISTANCE		
е	e 0.65 BSC			-	TERMINAL PITCH		

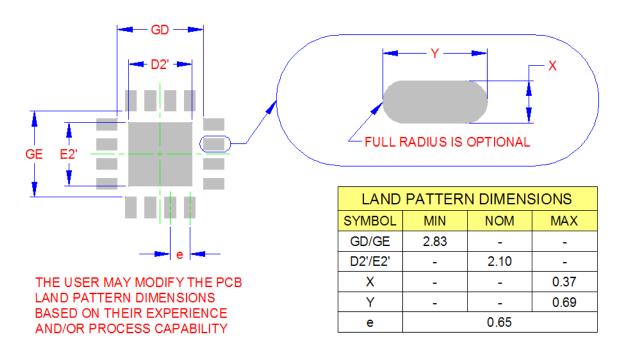
NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
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- 3. DETAILS OF TERMINAL #1 IDENTIFIER ARE OPTIONAL BUT MUST BE LOCATED WITHIN THE AREA INDICATED.

Figure 5 Preliminary 16-Pin QFN 4mm x 4mm Package Dimensions







RECOMMENDED PCB LAND PATTERN

Figure 7 Recommended PCB Footprint 16-Pin QFN 4mm x 4mm